

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

<b>Applicant:</b>	<b>Yew</b>	<b>Docket No:</b>	<b>TI-26239.1</b>
<b>Serial No:</b>	<b>10/612,129</b>	<b>Examiner:</b>	<b>Cao, Phat X.</b>
<b>Filed:</b>	<b>7/2/2003</b>	<b>Art Unit:</b>	<b>2814</b>
<b>For:</b>	<b>DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE</b>		

**APPEAL BRIEF PURSUANT TO 1.192(c)**

**Assistant Commissioner for Patents**  
**Washington, DC 20231**

Dear Sir,

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted  
by facsimile to the U.S. Patent and Trademark Office at 703-  
872-8308 on 2-3-05

Tommie Chambers  
Tommie Chambers

The following Appeal Brief is respectfully submitted in connection with the above identified application in response to the final rejection mailed August 6, 2004, and the Advisory Action mailed October 29, 2004.

## REAL PARTY IN INTEREST

**The real party in interest is Texas Instruments Incorporated.**

02/10/2005 GSTANLEY 0000404 10:00 10812129

01 FC:1402  
02 FC:1257

## RELATED APPEALS AND INTERFERENCES

Appellants legal representative knows of no appeals or interferences which will be directly affected, or have a bearing on the Board's decision.